



Press Release

Netvia Group acquires OLEC Microprint-DI Direct Imager March 1, 2016 Santa Ana, California

FABCON announces the sale of the new OLEC Microprint DI direct Imaging system to Netvia. Netvia Group, located in Irving Texas, has been manufacturing high end electronics industry since 1984. Focusing on telecommunications, military, medical and contract manufacturing, Netvia is a perfect fit for this new precision

technology. "With the demands of quick turn, complex and high reliability printed circuit board manufacturing, having laser direct imaging capability will help us to fulfill these objectives. We are pleased to offer this technological advantage to our clientele." Stated Mr. Jeff Forbus of the Netvia Group.

The technology answers industry demands for direct imaging of circuit boards. OLEC's renowned registration system and imaging platforms have been enhanced by adding the combination of collimated laser lighting with DLP direct imaging technology. The product can be configured to image; Flat Panel Displays, High Density Interconnect, Photo Chemical Machining, PCB Innerlayer, Outerlayers and Soldermask.

Bert Ohlig, chairman of Fabcon explains "The payback for the new

platform is extremely short with the increased yields from tight tolerance registration by eliminating the use of artwork photo-tools, short setup time, and the high resolution capability. The Microprint DI makes available the right tool for todays and tomorrow's imaging production demands." Greg Self, V.P. Electronics of Fabcon comments, "The industry is moving fast. With the introduction of the Microprint we can help our customers with ever changing demands at a good price"

Since 1977, Fabcon has provided products for the graphic arts, packaging, printed circuit, screen-print, and digital imaging markets under the OLEC brand. With distribution in over fifty countries, Fabcon is housed on a 13 acre site near Orange County Airport in Santa Ana, California.





